

# Working Instructions, SP/Mechanical

Applicable for Z200/Z208

### **Contents**

1	Disassembly		
2			11
3	Replac	cement of Mechanical Parts	<b>2</b> 1
	3.1	Upper Inside Assy	
	3.2	Dome Foil	22
3	Displa	y assembly	24
	3.2.1	Sub Display	26
	3.2.2	Main Display Assy	
	3.3	Battery Connector	
	3.4	Microphone Assy	31
	3.5	Earphone Assy	
	3.6	Load Speaker Assy (Polyphonic)	33
	4	Vibrator Assy	
	4.1	Flexfilm (BTB to FPC) & Upper PCB Assy	35
	4.2	Hinge Insert	37
	4.3	Hinge Mechanism	38
	4.4	Water Damage Indicator	39
	4.5	Magnet	
	4.6	Nameplate	41
5	Proces	ss Tools for Label	42
6	Revision	on History	43



# 1 Disassembly

#### **Process tools**

- Torque screwdriver, torx no.6 set to 11 Ncm
- Pair of tweezers
- Front opening tool. (NTZ 112 302)
- Flex Film Assembly tool. (NTZ 112521)

### **Equipment**

- ESD-gloves (cotton gloves)
- ESD-wristband

### Instruction

#	Figure	Instruction	Note
1	Fig 1.1	Release the battery cover and remove it.(Fig. 1.1.)	
2	Fig 1.2	Release the battery and remove it.(Fig.1.2.)	



#	Figure	Instruction	Note
3	Fig 1.3	Remove the 4 screws (Fig. 1.3.)	
4	Fig 1.4	Remove the Antenna/Hinge Cover (Fig 1.4)	By bend it in the same direction as the arrow point on the picture.
5	Fig 1.5	Use the Front opening tool to release the Rear Cover Assy from the Lower Inside Cover Assy. Place the tool between the Rear Cover Assy and the Lower Inside Cover Assy. Start with No 1 and then continue until you reach No 5 (Fig 1.5)	Place the Front opening tool as shown at the picture and follow the arrow indication No1 to No5.  Do not use a screwdriver or other sharp tools; it might cause some damage to the plastics or other components.
6	Fig 1.6	Remove the Sidekey with help of a pair of tweezers. (Fig 1.6)	



#	Figure	Instruction	Note
7	Fig 1.7	Remove the IrDA Window with your fingers (Fig. 1.7.)	The IrDA Window is easy to scratch. Do not use a pair of tweezers.
8	Fig 1.8	Remove the Top Cover from the Lower Inside Cover Assy, by lifting if straight up with help of a pair of tweezers. (Fig. 1.8.)	
9	Fig 1.9	Use a Front opening tool to release the Flexfilm from the board to board connector. (Fig 1.9)	
10	Fig 1.10	Remove the Conductive Copper Film from Shielding Case Lid (Fig 1.10)	Use a pair of tweezers to remove the Conductive Copper Film.



#	Figure	Instruction	Note
11	Fig 1.11	There are two snap hooks holding and positioning the PCB into the Lower Inside Cover Assy. (Fig. 1.11)	
12	Fig 1.12	Use a Front opening tool to release the left Snap hook in the Lower Inside Cover Assy. (Fig. 1.12.)	There is a risk of damaging the PCB or the Lower Inside Cover Assy if you are using sharp tools.
13	Fig 1.13	Release the PCB from the Lower Inside Cover Assy by grab hold of the System Connector with your fingers and lift. (Fig 1.13)	
14	Fig 1.14	Remove the Keypad with help of a pair of tweezers. (Fig. 1.14.)	



#	Figure	Instruction	Note
15	Fig 1.15	Lift the Exchange Cover with your thumb (1), and push it along the way of the arrow indication(2) (Fig 1.15)	
16	Fig 1.16	Use a pair of tweezers to press the Hinge Mechanism (Fig 1.16)	Put the tweezer into the cavity and push. At the same time use the thumb to push the Lower Inside Cover Assy in the arrow direction as shown in the picture.
17	Fig 1.17	Release the Upper Outside Cover Assy from the Lower Inside Cover Assy by pulling it apart, in the arrow direction as shown in the picture. (Fig. 1.17.)	Be careful not to damage the Flexfilm.
18	Fig 1.18	Untighten the 4 screws. (Fig. 1.18)	



#	Figure	Instruction	Note
19	Fig 1.19	Use the Guitar pick to release the Upper Inside Cover Assy from the Upper Outside Cover Assy.  Position and press the tool between the corner of Upper Inside Cover Assy and Upper Outside Cover Assy. (Fig 1.19)	Place the Guitar pick as shown at the picture.  Do not use a screwdriver or other sharp tools; it might cause some damage to the plastics or other components.  Be careful not to
[	Fig 1.20	Start as shown in the picture by sliding the tool from No.1 to No.2 and then from No.3 to No.4. (Fig 1.20)	damage the speaker.
20	Fig 1.21	Release and remove the Assistant Plate with help of a pair of tweezers. (Fig 1.21)	
21	Fig 1.22	Use a Front opening tool to release the Upper PCB from the Upper Outside Cover Assy. (Fig. 1.22.)	There is a risk of damaging the Upper PCB Assy or the Upper Outside Cover Assy if you are not using the Front opening tool.



#	Figure	Instruction	Note
22	Fig 1.23	Remove the Tape/ Zif connector on the Sub display connector. (Fig 1.23)	Use a pair of tweezers to remove the tape.
23	Fig 1.24	There are 2 hooks in the top of Sub Display. Use a Front opening tool to release the Sub Display from Main Display Assy. (Fig 1.24)	
24	Fig 1.25	Use a pair of tweezers to release the Sub Display connector by pulling the ZIF-connector lock in the direction of the arrows on the picture. (Fig 1.25)	
25	Fig 1.26	Use a Flex film assembly tool to remove the Sub Display flex film. (Fig 1.26)	



#	Figure	Instruction	Note
26	Fig 1.27	There are four snap hooks holding the Main Display Assy onto Sub PCB Use a Front opening tool to release the snap hooks Start with No.1 to No.2, as shown in the picture (Fig. 1.27.)	Press the Front opening tool between the Upper PCB Assy and Main Display Assy.
	Fig 1.28	Lift the Sub-PCB Assy up, and pull in the direction as the picure shows. (Fig. 1.28)	Use gloves.
27	Fig 1.29	Remove the Conductive Copper Film from the Main Display Assy. (Fig 1.29)	Use a pair of twezeers, as shown in the picture. Be careful not to damage the Main Display Assy.
28	Fig 1.30	Use a pair of tweezers to release the Main Display Assy connector by pulling the ZIF-connector lock in the direction of the arrows on the picture. (Fig. 1.30)	



#	Figure	Instruction	Note
29	Tiguit	Use a Flex film assembly tool to remove the Main Display Assy flexfilm. (Fig 1.31)	Note
	Fig 1.31		



## 2 Reassembly

### **Process tools**

- Torque screwdriver, torx no.6 set to 11 Ncm
- Pair of tweezers
- Flex Film Assembly tool.

### **Equipment**

- ESD-gloves (cotton gloves)
- ESD-wristband

### Instruction

#	Figure	Instruction	Note
1	Fig 2.1	Mount the Main display assy flex film in the Zif connector with a Flex film assembly tool. (Fig 2.1)	
2	Fig 2.2	Close the ZIF-connector with a pair of tweezers. (Fig 2.2)	Be careful so you don't harm the LCD flex film.



#	Figure	Instruction	Note
3	Fig 2.3	Place the Sub PCB Assy under the two snap hooks of Main Display Assy, as shown in the picure (Fig 2.3)	
4	Fig 2.4	Press the Sub PCB (arrow indication in the picture) to make it fit tightly to the Main Display Assy, start with arrow No.1 when continiue with No.2. (Fig 2.4)	
5	Fig 2.5	Mount the Sub display assy flex film in the Zif connector with a Flex film assembly tool. (Fig 2.5)	
6	Fig 2.6	Close the ZIF-connector with a pair of tweezers. (Fig 2.6)	Be careful so you don't harm the LCD flex film.



#	Figure	Instruction	Note
7	Fig 2.7	Place the Sub Display under the two hooks (as shown in the picture) into the cavity for the Sub display. Press on the Sub Display gently to make it fit into the Main Display Assy. (Fig 2.7)	Remember to remove the LCD protection tape. Press very gently at the surface.
8	Fig 2.8	Apply the Conductive Copper File for the Sub Display. (Fig 2.8)	
9	Fig 2.9	Apply the Sub LCD Connector Tape for Sub Display flex film (Fig 2.9)	
10	Fig 2.10	Apply the Conductive Copper Film for the Main Display Assy, as shown in the picure. (Fig 2.10)	



#	Figure	Instruction	Note
11	Fig 2.11	Place the Flexfilm into the cavity of Upper Outside Cover Assy as shown at the picture. (Fig 2.11)	
12	Fig 2.12	Press on the top of Main Display Assy to make it fit tightly into the Upper Outside Cover Assy. (Fig. 2.12)	Press until a click is heard, and then the Sub PCB should fit tightly into the Upper outside Cover Assy.
13	Fig 2.13	Position the Flex film Plate on the cavity of Upper Outside Cover Assy, with a pair of tweezzer, as shown in the picture. (Fig 2.13)	
14	Fig 2.14	Position the Upper Inside Cover Assy into the Upper Outside Cover Assy, as shown at the picture. (Fig 2.14)	Make sure the Vibrator, Magnet, and Flex film Plate has been mounted correctly before you reassemble the Upper Inside Cover Assy.



#	Figure	Instruction	Note
15	Fig 2.15	Mount the Upper Inside Cover Assy into the Upper Outside Cover Assy. Start on the top and press on each side (follow the arrow indication) of it with your fingers until it fits tifhtly. (Fig 2.15)	Arrows indicate where to press A click sound should be heard
16	Fig 2.16	Tighten the 4 screws, in the same order as the arrows in the picture. start with No.1 to No.4. (Fig 2.16)	
17	Fig 2.17	Position the Board to board Flexfilm on the cavity of Lower Inside Cover Assy, as shown at the picture. (Fig 2.17)	Make sure that the
	Fig 2.18		Board to board flexfilm is in the correct position, according to the picture. (Fig 2.18)



#	Figure	Instruction	Note
18	Fig 2.19	Press the Lower Inside Cover Assy as shown at the picture. Push the Upper Outside Cover Assy onto the Lower Inside Cover Assy. (Fig 2.19)	Important that the angle of the phone is the same as in the picure.
19	Fig 2.20	Use a pair of tweezers to press the Hinge Mechanism. Assemble the Upper Outside cover Assy and the Lower Inside Cover Assy. (Fig 2.20)	Be careful, do not harm the cover.
20	Fig 2.21	Position the Keypad inside the Lower Inside Cover Assy. (Fig 2.21)	



#	Figure	Instruction	Note
21	Fig 2.22	Place the Main PCB in the Lower Inside Cover Assy. Press the Main PCB under the Snap hooks, as the arrow indication shows on the picture. Press on the Main PCB to make it fit correctly. (Fig 2.22)	
		Mount the Sidekey FPC in the cavity in the Rear Cover Assy.	Make sure that the Sidekey FPC is positioned correctly. (Fig 2.23)
	Fig 2.23  Fig 2.24	Antenna Conn.  O OK  X	Make sure that the antenna connector and antenna flex film is connected well. (Fig 2.24) See picture as left.



#	Figure	Instruction	Note
22	Fig 2.25	Connect the Flexfilm (BTB to FPC) to the board to board connector with your fingers.  Apply the Conductive Copper Film, as shown in the picure. (Fig 2.25)	
23	Fig 2.26	Mount the Top Cover into the Lower Inside Cover Assy. (Fig 2.26)	
24	Fig 2.27	Mount the IrDA Window into the Lower Inside Cover Assy with your fingers. (Fig 2.27)	The IrDA Window is easy to scratch. Do not use a pair of tweezers.  Do not invert the IrDA Window when you mount it. See description for position of mounting in the picture.
25	Fig 2.28	Mount the Sidekey into the Lower Inside Cover Assy with a pair of tweezers. (Fig 2.28)	Do not invert the Sidekey when you mount it. (The longer pin should be down) See description for position of Sidekey, in the picture.



#	Figure	Instruction	Note
26	Fig 2.29	Position the Rear Cover Assy at a 30° on the top of Lower Inside Cover Assy, according to the picture. (Fig. 2.29)	Make sure that the Rear Cover Assy extends over the Lower Inside Cover Assy as shown by the red circle.
27	Fig 2.30	Press on each side of it with your fingers to make it fit tightly. (Fig 2.30)	Arrows indicate where to press
28	1 3 3 4 Fig 2.31	Tighten the 4 screws, according to the arrow incation No.1 to No.4. (Fig 2.31)	Make sure the Top Cover, IrDA Window, and Sidekey will be correct positioned before you tighten the 4 screws.
29	Fig 2.32	Mount the Antenna/Hinge Cover. (Fig 2.32)	



#	Figure	Instruction	Note
30		Position the Exchange cover onto the Uppper Outside Cover Assy, Push the exchange cover (1) and press it (2) (Fig 2.33)	Follow the arrows on the picture.
	Fig 2.33		
31	Fig 2.34	Connect the Battery. (Fig 2.34)	
32	Fig 2.35	Assemble the Battery Cover. (Fig 2.35)	



## 3 Replacement of Mechanical Parts

## 3.1 Upper Inside Assy

#### **Process tools**

Pair of Tweezers.

#### Instruction

• Disassemble the phone as described in 1 Disassembly (page 2-7), follow steps 1-19.

#	Figure	Instruction	Note	
1		Remove the Vibrator Assy by positioning a pair of tweezers under the flywheel and lift. (Fig 3.1.1)		
	Fig 3.1.1			
2	D.1130903	Take a new Upper Inside Cover Assy and mount the Vibrator Assy. (Fig 3.1.2)	Do not press on the flywheel, it can cause damage on the vibrator.	
	Fig 3.1.2			

• Assemble the phone as described in 2 reassembly (page 14-20), follow steps 13-34.



### 3.2 Dome Foil

### **Process tools**

• Pair of Tweezers.

### Instruction

• Disassemble the phone as described in 1 Disassembly (page 2-5), follow steps 1-13.

#	Figure	Instruction	Note
1	Fig 3.2.1	Remove the Conductive Sponge with a pair of tweezers. (Fig 3.2.1)	
2	Fig 3.2.2	Remove the old Dome foil, with a pair of tweezers. (Fig 3.2.2)	Do not touch the dome and PCB.
3	Fig 3.2.3	Replace the new Dome foil on the PCB. Aim the dome foil according to the guide holes on the PCB as shown in the picture. (Fig 3.2.3)	Do not touch the dome foil or PCB. Clean the PCB surface from glue and dust. Always use a pair of tweezers.



#	Figure	Instruction	Note
4	Fig 3.2.4	Mount the Conductive Sponge into the correct position as shown in the picture. (Fig 3.2.4)	

• Assemble the phone as described in 2 reassembly (page 16-20), follow steps 20-32.



## 3 Display assembly

#### **Process tools**

- Tweezers.
- Flex Film Assembly tool.

#### **Instructions**

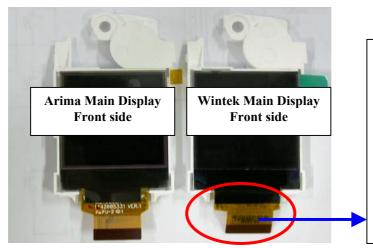
#### Note:

Today we have displays from two different vendors, Wintek and Arima Display.

It is important that the main display and sub display in the phone are from the same vendor. This means that if you have a main display from Wintek it requires a sub display from Wintek as well in order to get functionality.

See instruction below how to identify the different variants of displays:

LCD	Main LCD	Sub LCD	Result
	Arima Display	Arima Display	OK
Vendor	Arima Display	Wintek	X
venuor	Wintek	Arima Display	X
	Wintek	Wintek	OK



Date Code:

Ex. 32C21/04

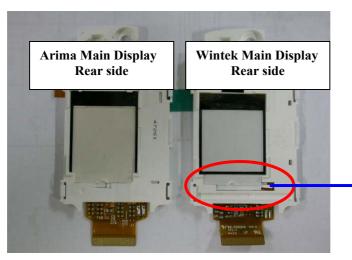
32: Week

C: Factory 21: Line No.

04: Year

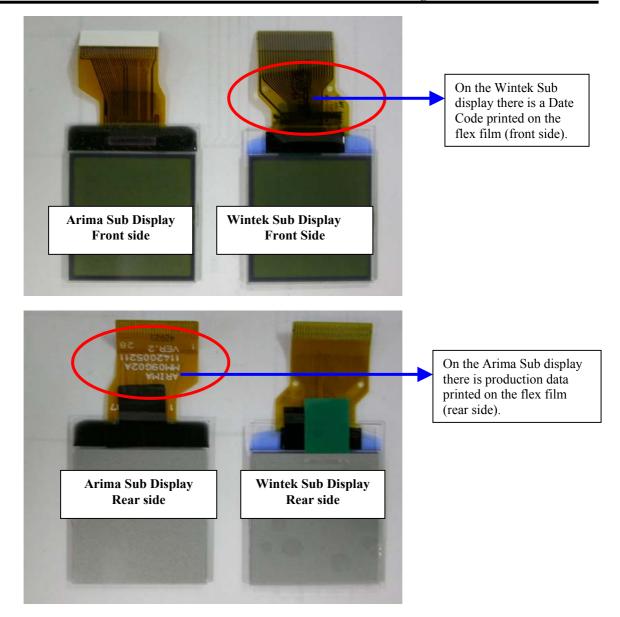
(The date code is W432)

Make sure that this data is printed on the Flex film on the Main Display from Wintek (front side).



On the Wintek display there is significant differences in the marked area compared to the Arima Display (Rear side).





NOTE! When using and replacing an Wintek's LCD, please do not forget to upgrade the software to R6C. Otherwise, the phones will show no display (Wintec is only working with R6C SW).



### 3.2.1 Sub Display

• Disassemble the phone as described in 1 Disassembly (page 2-8), follow steps 1-23.

#	Figure	Instruction	Note
1	Fig 3.3.1	Release the Sub Display connector by pulling the ZIF-connector lock upwards. (Fig 3.3.1)	Be careful so you don't damage the LCD flex film.
2	Fig 3.3.2	Remove the Sub Display flex film with a Flex film assembly tool. (Fig 3.3.2)	
3		Pick up a new Sub Display.	Avoid any contact with all surfaces. Use gloves.



#	Figure	Instruction	Note
4	Fig 3.3.3	Mount the Sub display flex film in the Sub Display connector with the Flex film assembly tool. (Fig 3.3.3)	
5		Close the ZIF-connector	Be careful so you
	Fig 3.3.4	with a pair of tweezers as shown at the picture. (Fig 3.3.4)	don't damage the Sub display flex film.
	1 tg 5.5.4	Alas da a Carla I CD	
6	Fig 3.3.5	Apply the Sub LCD Connector Tape (Fig 3.3.5)	

• Assemble the phone as described in chapter 2 reassembly (page 11-20), follow steps 10-32.



### 3.2.2 Main Display Assy

• Disassemble the phone as described in 1 Disassembly (page 2-10), follow steps 1-29.

#	Figure	Instruction	Note
1	Fig 3.3.6	Remove the Earphone Assy with a pair of tweezers by lifting it upwards. (Fig. 3.3.6)	Do not touch the spring connectors.
2	Fig 3.3.7	Remove the Load Speaker (Polyphonic) Assy with a pair of tweezers. (Fig. 3.3.7)	Do not touch the spring connectors.
3		Pick up a new Main Display Assy.	Avoid any contact with all surfaces. Use gloves.
4	Fig 3.3.8	Mount the Load Speaker (Polyphonic) Assy in the cavity with the spring connectors facing upwards. (Fig. 3.3.8)	Do not press on the spring connectors.



#	Figure	Instruction	Note
5	Fig 3.3.9	Apply the Earphone gasket in the cavity. (Fig 3.3.9)	Clean the Earphone gasket of residual in the cavity clearly before apply it.
6	Fig 3.3.10	Mount the Earphone Assy in the cavity with the spring connectors facing upwards. (Fig. 3.3.10)	Do not press on the spring connectors.
7	Fig 3.3.11	Apply the Earphone outer gasket (Fig 3.3.11)	
8	Fig 3.3.12	Apply the Display gasket. (Fig 3.3.12)	

• Assemble the phone as described in 2 reassembly (page 11-20), follow steps 10-32.



### 3.3 Battery Connector

### **Process tools**

• Pair of tweezers.

### Instruction

• Disassemble the phone as described in 1 Disassembly (page 2-3), follow steps 1-5.

#	Figure	Instruction	Note
1	Fig 3.4.1	Use a pair of tweezers to remove the Battery Connector from the Rear Cover Assy. (Fig. 3.4.1)	Be careful not to damage the spring connectors.
2		Pick up a Battery Connector with a pair of tweezers	Make sure that the Battery Connector not is bend or damage in any way.
3	Fig 3.4.2	Mount the Battery Connector into the cavity in the Rear Cover Assy. (Fig. 3.4.2)	Make sure that the Battery Connector is fitting correct and that it is not damage in any way. If the connector is bend or it does not fit correct, replace it.

• Assemble the phone as described in 2 reassembly (page 18-20), follow steps 26-32.



## 3.4 Microphone Assy

### **Process tools**

• Pair of tweezers.

### Instruction

• Disassemble the phone as described in 1 Disassembly (page 2-5), follow steps 1-13.

#	Figure	Instruction	Note
1	Fig 3.5.1	Remove the Microphone Assy by using a pair of tweezers. (Fig. 3.5.1)	
2		Pick up the new Microphone Assy with a pair of tweezers.	
3	Fig 3.5.2  Microphone  System Connector  Microphone  System Connector	Mount the Microphone Assy in the Microphone Connector, located on the Main PCB. (Fig 3.5.2)	Make sure that the polarity is correct. (See picture and explaination below.)

Assemble the phone as described in 2 reassembly (page 17-20), follow steps 21-32.



### 3.5 Earphone Assy

### **Process tools**

• Pair of tweezers.

### Instruction

• Disassemble the phone as described in 1 Disassembly (page 2-10), follow steps 1-29.

#	Figure	Instruction	Note
1	Fig 3.6.1	Remove the Earphone Assy with a pair of tweezers by lifting it upwards. (Fig. 3.6.1)	Do not touch the spring connectors.
2	Fig 3.6.2	Apply the Earphone gasket in the cavity. (Fig 3.6.2)	Clean the residual of Eapphone gasket in the cavity clearly before apply it.
3		Pick up a new Earphone Assy with a pair of tweezers.	
4	Fig 3.6.3	Mount the Earphone Assy in the cavity with the spring connectors facing upwards. (Fig 3.6.3)	Do not press on the spring connectors.

• Assemble the phone as described in 2 reassembly (page 11-20), follow steps 1-32.



## 3.6 Load Speaker Assy (Polyphonic)

### **Process tools**

• Pair of tweezers.

### Instruction

• Disassemble the phone as described in 1 Disassembly (page 2-10), follow steps 1-29.

#	Figure	Instruction	Note
1	Fig 3.7.1	Remove the Load Speaker Polyphonic Assy with a pair of tweezers. (Fig. 3.7.1)	Do not touch the spring connectors.
2		Pick up a new Load Speaker Polyphonic with a pair of tweezers.	
3	Fig 3.7.2	Mount the Load Speaker Polyphonic Assy in the cavity with the spring connectors facing upwards. (Fig. 3.7.2)	Do not press on the spring connectors.

• Assemble the phone as described in 2 reassembly (page 11-20), follow steps 1-32.



### 4 Vibrator Assy

### **Process tools**

• Pair of tweezers.

### Instruction

• Disassemble the phone as described in 1 Disassembly (page 2-7), follow steps 1-19.

#	Figure	Instruction	Note
1	Fig3.8.1	Remove the Vibrator Assy by lifting in the vibrator Coating, with a pair of tweezers . (Fig. 3.8.1)	
2		Pick up a New vibrator Assy.	
3	Fig 3.8.2	Mount the Vibrator Assy with the help of a pair of tweezers, and position it in the cavity of the Upper Inside Assy. (Fig 3.8.2)	Press exactly as shown at the picture. Press the vibrator unit it reaches the bottom of the cavity. Do not press on the flywheel, it can cause damage on the vibrator.
	1 ig 3.0.2		

• Assemble the phone as described in 2 reassembly (page 14-20), follow steps 13-32.



## 4.1 Flexfilm (BTB to FPC) & Upper PCB Assy

### **Process tools**

- Pair of tweezers.
- Flex Film Assembly tool.

### Instruction

• Disassemble the phone as described in 1 Disassembly (page 2-10), follow steps 1-29.

#	Figure	Instruction	Note
1	Fig 3.9.1	Remove the Tape/Zif Connector with a pair of tweezers. (Fig. 3.9.1)	
2	Fig 3.9.2	Release the Flexfilm (BTB to FPC) connector by pulling the ZIF-connector lock upwards with a pair of tweezers, as shown at the picture. (Fig 3.9.2)	Be careful so you don't damage the Flexfilm.
3	Fig 3.9.3	Remove the Flexfilm (BTB to FPC) with a Flex film Assembly tool. (Fig 3.9.3)	



#	Figure	Instruction	Note
4		Pick up a New Flexfilm (BTB to FPC) or Upper PCB Assy.	
5	Fig 3.9.4	Mount the Flexfilm (BTB to FPC) in the Sub PCB Zif-connector with a Flex film Assembly tool. (Fig 3.9.4)	
6	Fig 3.9.5	Close the ZIF-connector with a pair of tweezers as shown at the picture. (Fig 3.9.5)	Be careful so you don't damage the LCD flex film.  Do not mount the Flexfilm in the wrong direction.
7		Pick up a new Tape/Zif connector.	
8	Fig 3.9.6	Apply the Tape/Zif connector with a pair of tweezers. (Fig 3.9.6)	

• Assemble the phone as described in 2 reassembly (page 11-20), follow steps 1-32.



## 4.2 Hinge Insert

### **Process tools**

• Pair of tweezers.

### Instruction

• Disassemble the phone as described in 1 Disassembly (page 6-6), follow steps 16-17.

- ,,	E.	T 4 4:	NI 4
#	Figure	Instruction	Note
1	Fig3.10.1	Remove the Hinge Insert from the Lower Inside Cover Assy with a pair of tweezers as shown at the picture. (Fig 3.10.1)	
2		Pick up a new Hinge Insert.	
3	Fig 3.10.2	Mount the Hinge Insert to the Lower Inside Cover Assy with a pair of tweezers as shown at the picture. (Fig 3.10.2)	
	Fig3.10.2		

• Assemble the phone as described in 2 reassembly (page 15-20), follow steps 16-32.



## 4.3 Hinge Mechanism

### **Process tools**

• Pair of tweezers.

### Instruction

• Disassemble the phone as described in 1 Disassembly (page 6-6), follow steps 15-17.

#	Figure	Instruction	Note
1	Fig 3.11.1	Remove the Hinge Mechanism from the Upper Outside Cover Assy with a pair of tweezers. (Fig3.11.1)	
2		Pick up a new Hinge Mechanism.	
3	Fig 3.11.2	Mount the Hinge Mechanism into the Upper Outside Cover Assy with a pair of tweezers. (Fig3.11.2)	

• Assemble the phone as described in 2 reassembly (page 16-20), follow steps 17-32.



## 4.4 Water Damage Indicator

### **Process tools**

• Pair of tweezers.

### Instruction

• Disassemble the phone as described in 1 Disassembly (page 2-3), follow steps 1-5.

#	Figure	Instruction	Note
1	Fig3.12.1	Remove the Water Damage Indicator from the Rear Cover Assy with a pair of tweezers. (Fig 3.12.1)	
2		Pick up a new Water Damage Indicator.	
3		Apply the Water Damage Indicator with a pair of tweezers. (Fig 3.12.2)	
	Fig 3.12.2		

• Assemble the phone as described in 2 reassembly (page 19-20), follow steps 28-32.



### 4.5 Magnet

### **Symptom**

• If the background light is turned on when the shell is closed, or if the Main display takes long time to load up when the shell is opened, reverse the magnet according to the instruction below.

### **Process tools**

• Pair of tweezers.

### Instruction

#	Figure	Instruction	Note
1	Fig 3.13.1	Make a mark on the Magnet as shown in the picture. (Fig 3.13.1)	Make sure the magnet is not mechanically damaged, dirty or oxidized.
2	Fig 3.13.2	Remove the Magnet from the cavety in Upper Inside Cover, use a pair of twezzers. (Fig 3.13.2).	
3	Fig 3.13.3	Reverse the Magnet and replace it in the cavety. (The mark is at the bottom) (Fig 3.13.3)	If the problem still occours, replace Upper Inner Cover. See chapter 3.1 Upper inside Cover



## 4.6 Nameplate

### **Process tools**

• Pair of tweezers.

### Instruction

• Flip the cover.

#	Figure	Instruction	Note
1	Fig3.14.1	Remove the old Nameplate from the Lower Inside Cover Assy with a pair of tweezers. (Fig 3.14.1)	Be careful so you don't scratch the Lower Inside Cover Assy.
2		Pick up a new Nameplate.	Don't reuse used Nameplate
3		Apply the Nameplate with a pair of tweezers. (Fig 3.14.2)	Make sure that the surface is clean before applying the new Nameplate.
	Fig 3.14.2		



## **5** Process Tools for Label

- Hot air blower
- Pair of tweezers

### Instruction

This instruction should be used when you intend to exchange an old Label Markingplate or mount a new one.

- 1. Heat up the Label Markingplate with a hot air blower.
- 2. Carefully remove the label, make sure that all the residue is remove. Do not scratch the frame.

**Note!** Only one Label Markingplate is allowed in the battery cavity.

3. Printing: The text must be fully readable visually and through bar code readers.

#	Figure	Instruction	Note
1	Fig 4.1	Take the new Label Markingplate and place it in the battery cavity. The Label Markingplate should be centred and parallel to the sides of the cavity. (Fig. 4.1)	Make sure that there are no air bubbles under the label.



# **6 Revision History**

Rev.	Date	Changes / Comments	
A	2003-10-30	First release	
В	2004-04-29	Added chapter 3.13 Magnet and chapter 3.14 Nameplate	
С	2004-07-28	Updated chapter 2 Reassemble (page 13, "Sub LCD	
		connector tape), 3.3 Display assembly (page 25 "LCD	
		Connector tape", page 27 "Earphone outer gasket") and	
		3.6 Earphone Assy. (page 30 "Earphone gasket")	
D	2004-10-07	Updated chapter 3 Display Assembly	
Е	2004-10-25	Page 25 (reg the the two displays "Arima and Wintec"	
		LCD), just adding the missing (but important)	
		information: "Don't forget to update to SW R6C SW when	
		using Wintec LCD".	